

**FEATURES**

RS1AA~RS1MA are available in SMA Package

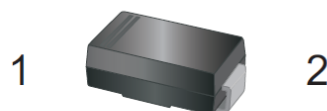
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time.
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.055g / 0.002oz

ORDERING INFORMATION

Package Type	Part Number
SMA	RS1AA
	RS1BA
	RS1DA
	RS1GA
	RS1JA
	RS1KA
	RS1MA
SPQ	5,000pcs/Reel
AiT provides all RoHS Compliant Products	

PIN DESCRIPTION

SMA Package



PIN#	DESCRIPTION
1	Cathode
2	Anode

**ABSOLUTE MAXIMUM RATINGS**T_A = 25°C, unless otherwise specified.

Parameter	Symbols	RS1AA	RS1BA	RS1DA	RS1GA	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	V
Maximum Average Forward Rectified Current at T _c = 125 °C	I _{F(AV)}	1				A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30				A
Maximum Forward Voltage at 1 A	V _F	1.3				V
Maximum DC Reverse Current T _A = 25 °C at Rated DC Blocking Voltage T _A =125 °C	I _R	5 50				μA
Typical Junction Capacitance at V _R =4V, f=1MHz	C _J	15				pF
Maximum Reverse Recovery Time ⁽¹⁾	t _{rr}	150				ns
Typical Thermal Resistance ⁽²⁾	R _{θJA}	75				°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 ~ +150				°C
Parameter	Symbols	RS1JA	RS1KA	RS1MA	Unit	
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	600	800	1000	V	
Maximum RMS voltage	V _{RMS}	420	560	700	V	
Maximum DC Blocking Voltage	V _{DC}	600	800	1000	V	
Maximum Average Forward Rectified Current at T _c = 125 °C	I _{F(AV)}	1				A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30				A
Maximum Forward Voltage at 1 A	V _F	1.3				V
Maximum DC Reverse Current T _A = 25 °C at Rated DC Blocking Voltage T _A =125 °C	I _R	5 50				μA
Typical Junction Capacitance at V _R =4V, f=1MHz	C _J	15				pF
Maximum Reverse Recovery Time ⁽¹⁾	t _{rr}	250	500		ns	
Typical Thermal Resistance ⁽²⁾	R _{θJA}	75				°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 ~ +150				°C

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Measured with I_F = 0.5 A, I_R = 1 A, I_{rr} = 0.25 A.

(2) P.C.B. mounted with 1.0 X 1.0" (2.54 X 2.54 cm) copper pad areas.



TYPICAL CHARACTERISTICS

Fig 1. Forward Current Derating Curve

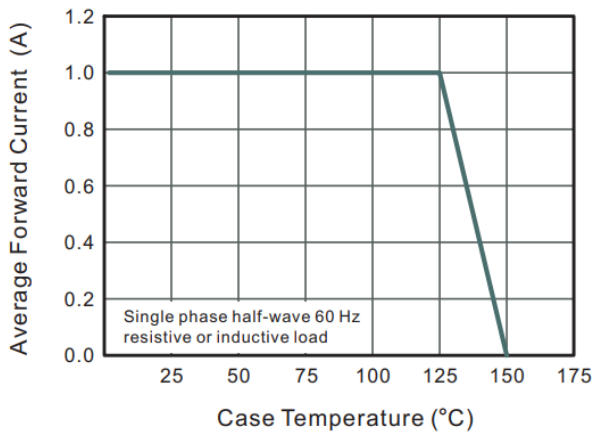


Fig 2. Typical Reverse Characteristics

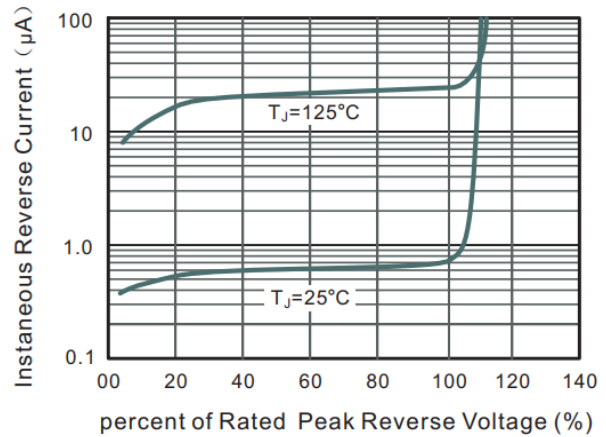


Fig 3. Typical Instantaneous Forward Characteristics

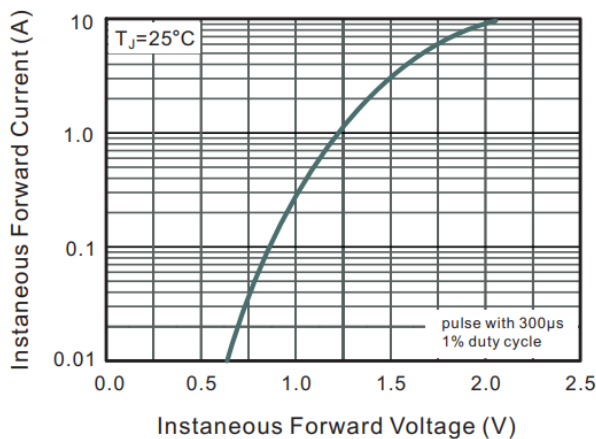


Fig 4. Typical Junction Capacitance

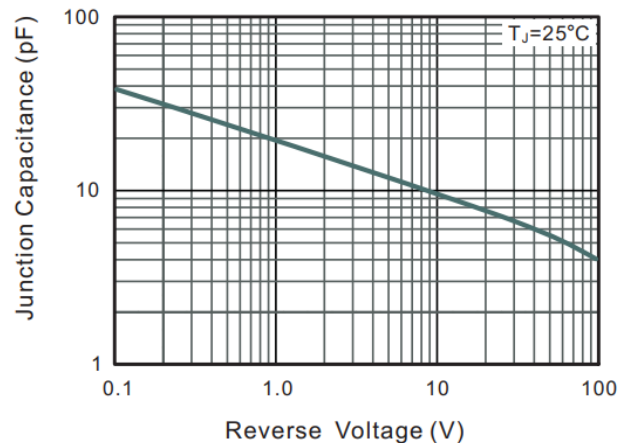
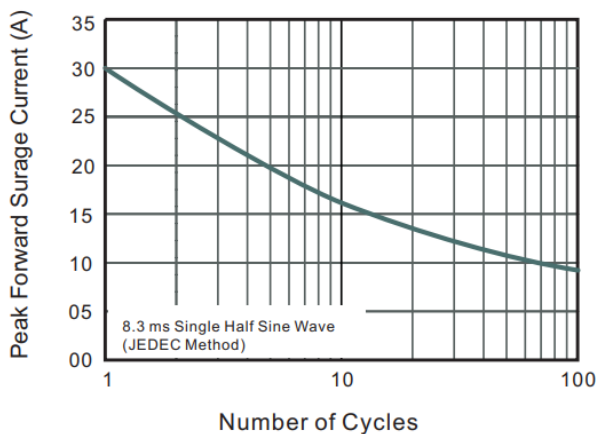


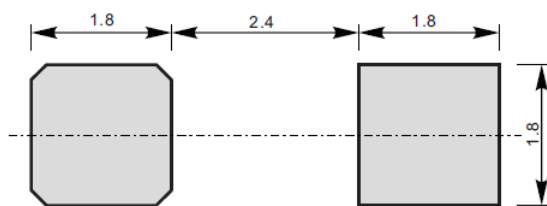
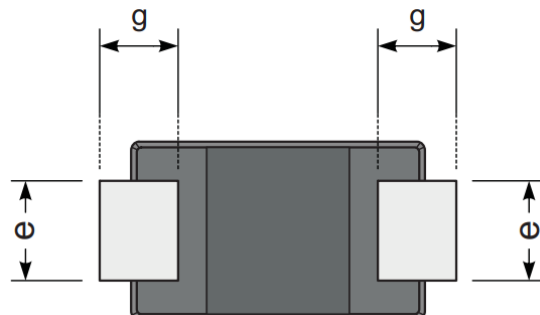
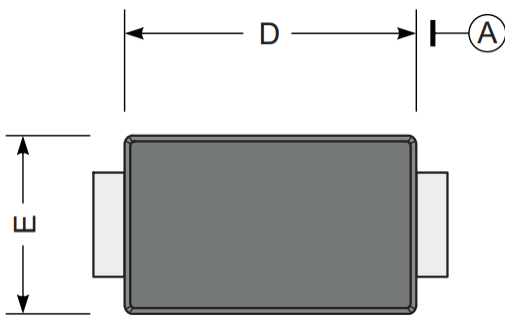
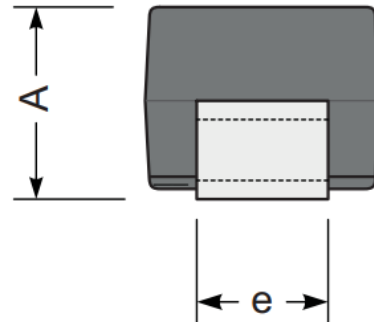
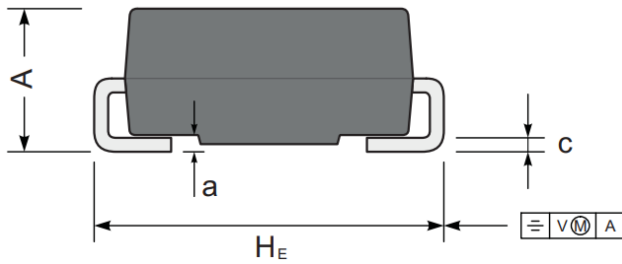
Fig 5. Maximum Non-Repetitive Peak Forward Surge Current





PACKAGE INFORMATION

Dimension in SMA Package (Unit: mm)



Recommended Mounting Pad Size

Symbol	Min	Max
A	1.9	2.45
D	4.0	4.5
E	2.5	2.8
H _E	4.7	5.2
c	0.15	0.31
e	1.3	1.8
g	0.9	1.5
b	0.05	0.2
a	0.3	



IMPORTANT NOTICE

AiT Semiconductor Inc. (AiT) reserves the right to make changes to any its product, specifications, to discontinue any integrated circuit product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

AiT Semiconductor Inc. integrated circuit products are not designed, intended, authorized, or warranted to be suitable for use in life support applications, devices or systems or other critical applications. Use of AiT products in such applications is understood to be fully at the risk of the customer. As used herein may involve potential risks of death, personal injury, or server property, or environmental damage. In order to minimize risks associated with the customer's applications, the customer should provide adequate design and operating safeguards.

AiT Semiconductor Inc. assumes to no liability to customer product design or application support. AiT warrants the performance of its products of the specifications applicable at the time of sale.